



XMC-E6760

Graphics XMC Mezzanine Card

USER MANUAL

REV1.0

Air Cooled version

Conduction Cooled version

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WARNING

Thank you for choosing C3itop's Graphics XMC mezzanine card. The relevant safety precautions for this product are described as below. The operator and all staff who may be involved in the operation must be fully aware of the contents of this manual to ensure the safety of persons and devices.

I Description of safety signs

Safety signs involved in the device means as following:

Prohibitions:



No smoking

Smoking is prohibited while the device is working



No burning

Burning is prohibited while the device is working

Ensure fire safety facilities / equipment in good condition



No demolition

Warnings



Warning danger



Warning electric shock

II Basic safety precautions

- 1) The operator should go through the system operation training, and Maintenance personnel should go through the system maintenance training
- 2) The device must be powered on and powered off according to the procedure set forth herein

III Other safety precautions

- It is recommended to use anti-static gloves to prevent electrostatic damage, when plug and unplug the device.
- The device needs to be put into static bag when it was transported in single board or was stored
- When transporting the device, the package should be fitted with shock-absorbing protective measures to prevent extrusion, collision or damage during the transport process.
- When the device needs to be stored , you should pay attention to ventilation, damp proof, dust proof, not stored together with corrosive substances
-

IV The operation procedures

- The hardware configuration should be in accordance with the instructions; check the device connected to the board to make sure the connection is correct, particularly check if the output voltage(+12V, +5V,+3.3V) of power supply equipment meets the requirements or not.

1. INTRODUCTION

1.1 General

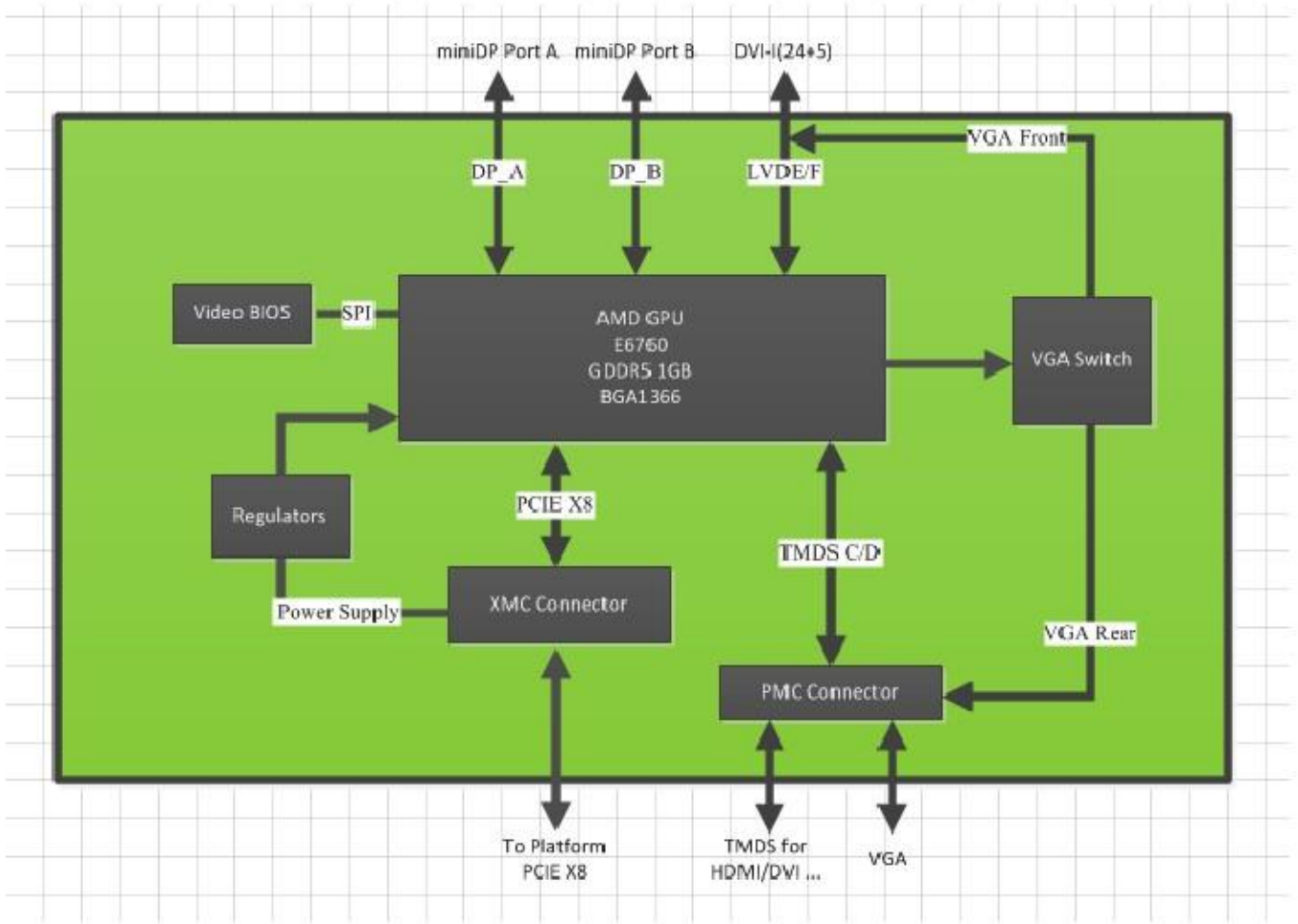
This manual is a guide and reference handbook for engineers and system integrators who wish to use the C3itop Technologies XMC-E6760 graphics XMC mezzanine card. The board has been designed for high-quality display and multiple independent display output. It is a wide operating temperature product. The ordering information is list as below,

Product name	Ordering code	Description
XMC-E6760	10-0000-0168	AMD E6760, 1GB GDDR5,consumption 25w~45w, X8 PCIE2.0, 2x MiniDP front IO 1x DVI-I (Dual link DVI+VGA)front IO, 2x TMDS rear IO,1x VGA rear optional.

The board is available in standard or express temperature and air-cooled versions, Throughout this manual, references to the board will use the generic name XMC-E6760, unless they apply to a specific variant, in which case the full name will be used.

The information contained in this manual has been written to provide users with all the information necessary to configure, install and use the XMC-E6760 as part of a system. It assumes familiarity with XMC and concepts, and with X86 computer architectures and features.

1.2 Block Diagram

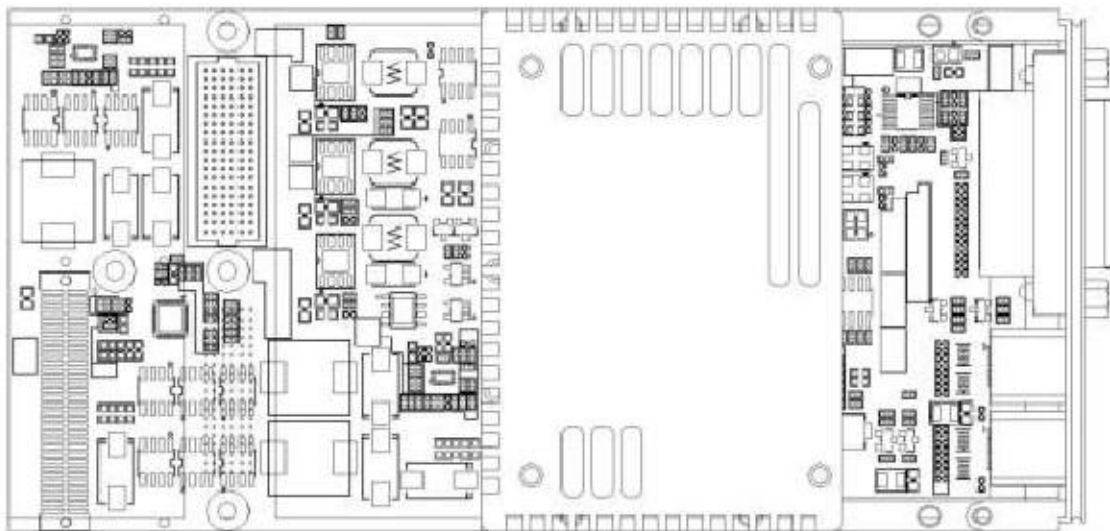


2. HARDWARE INSTALLATION

2.1 Air Cooled

2.2.1 Installation of XMC-E6760 Air Cooled radiator

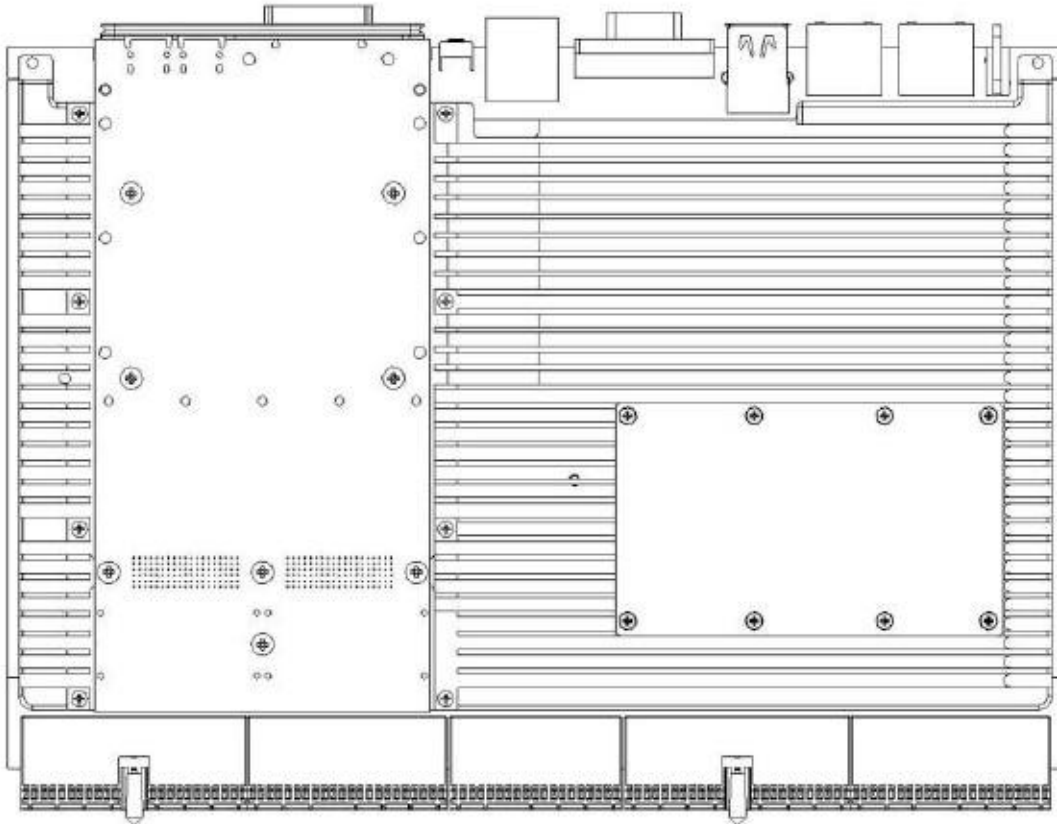
- 1) Place the module topside upward
- 2) Align the screw holes and the radiator module placement
- 3) Install the pan head screws



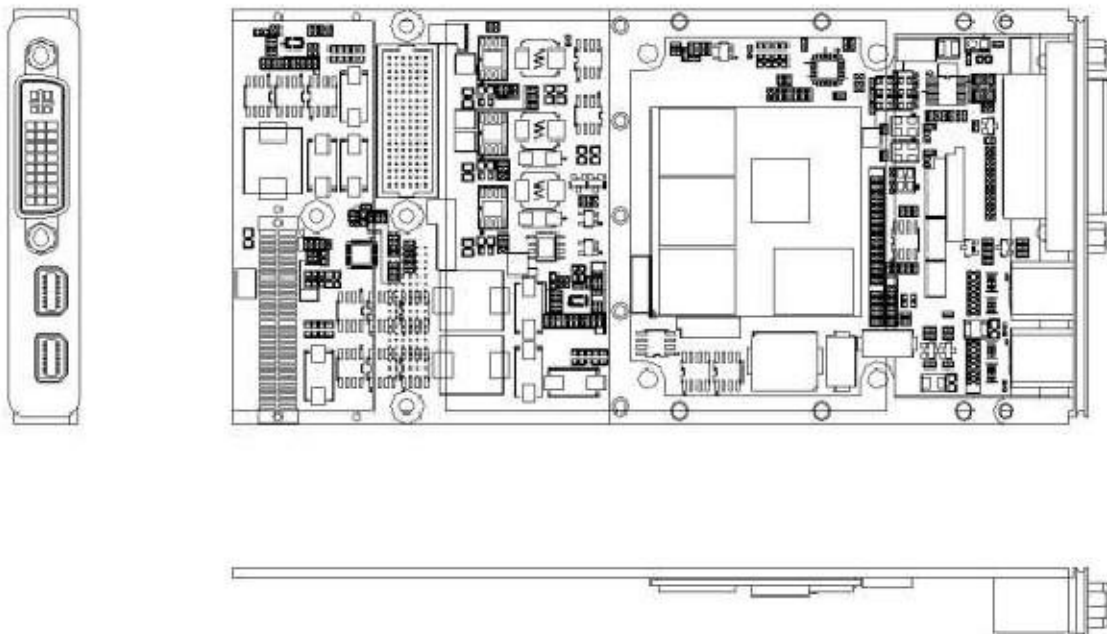
2.2.2 Installation of a XMC-E6760 Module on 6U SBC

- 1) Remove the top side cover.
- 2) Align the holes at the front and middle of the XMC-E6760 with the matching holes on the sbc
- 3) Lower the XMC module, component side down, fitting the XMC connectors into their mating connectors. Press them together so that the friction from the pins holds the XMC module in place.

4) Install the 8 pan head screws.



2.2.3 Installation of a front panel on XMC-E6760



3. SPECIFICATIONS

3.1 Functional Specification

- AMD™ E6760 GPU 600MHz
- 576 GFLOPS GPGPU
- Rugged air-cooled with revolutionary heatplate design
- 1GB GDDR5 memory, 800MHz 128-bit
- Standard XMC form factor (VITA 42.3)
- PCIe 2.1 x8 bus interface
- Up to 5 independent digital outputs

3.2 Environment Specification

3.2.1 Storage Temperature

XMC-E6760 might be malfunction and be mechanically damaged if stored out of the temperature range from -55°C to +85°C.

3.2.2 Working Temperature

The working temperature of XMC-E6760 can be extended to -40~+70°C as industrial grade.

3.2.3 Power Requirement

The power consumption of XMC-E6760 is about 25~45Watt according to the respective load conditions. The primary power inputs of XMC-E6760 is +5V, or +12V. It depends on the SBC you are using. The voltage level range can be less than +5V or +12V $\pm 5\%$.

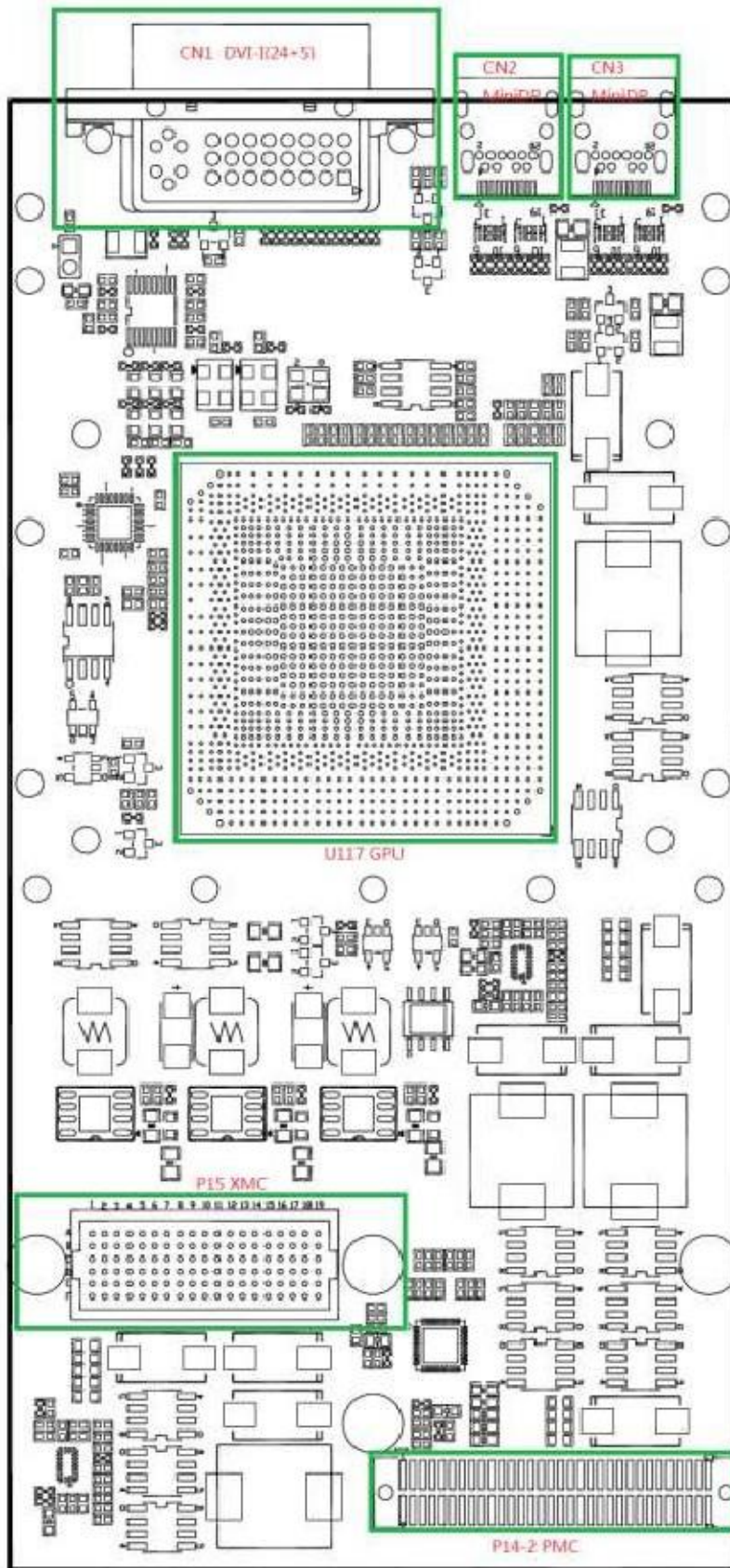
3.2.4 Board Size

Length x Width: 74x149 (mm)

4. PHYSICAL CHARACTERISTICS

4.1 Main Components Location

Main components location as below:



4.2 Front Panel Connectors

4.3.1 Front panel connectors drawings

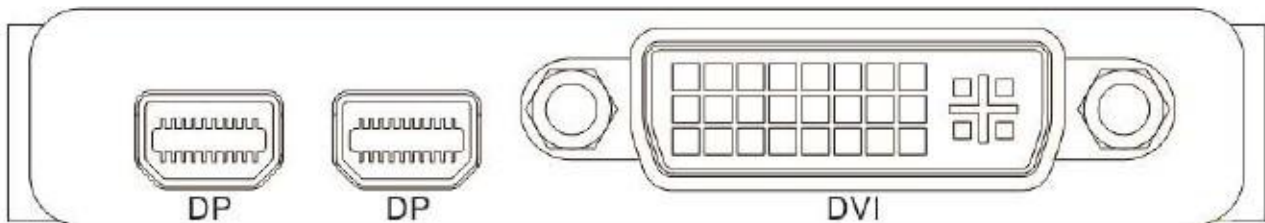


Figure 3-2 The left drawing is no XMC board installed, the right drawing is XMC board installed

4.3.2 Front panel DVI-I

CN1 in front panel is standard DVI-I connector. It can be connected to standard Dual-Link DVI and VGA display ports. Figure 3-3 and table 3-3 is pin out description.

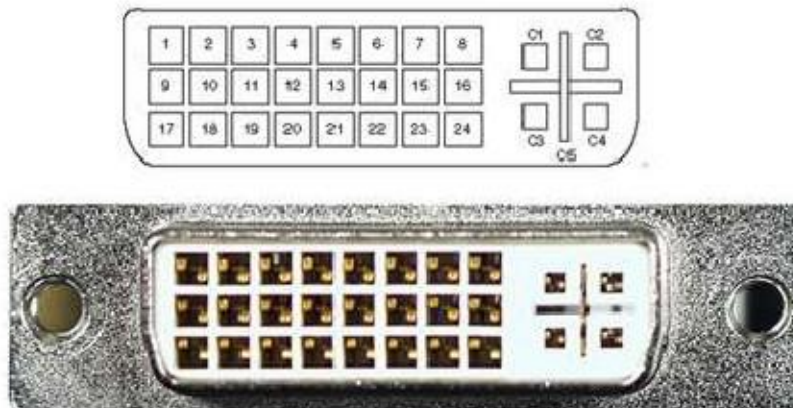


Figure 3-3

Pin	Signal	Pin	Signal	Pin	Signal
1	DVI_TX2N	9	DVI_TX1N	17	DVI_TX0N
2	DVI_TX2P	10	DVI_TX1P	18	DVI_TX0P
3	GND	11	GND	19	GND
4	DVI_TX4N	12	DVI_TX3N	20	DVI_TX5N
5	DVI_TX4P	13	DVI_TX3P	21	DVI_TX5P
6	DVI_SCL	14	CRT_VCC	22	GND
7	DVI_SDA	15	GND	23	DVI_CLKP
8	CRT_VSYNC	16	DVI_HPD	24	DVI_CLKN
C1	CRT_RED	C2	CRT_GREEN	C3	CRT_BLUE
C4	GND	C5	GND		

Table 3-3

4.3.3 Front MiniDP Connectors

2 front MiniDP ports are supported on this board.

CN2, CN3 are standard mini-display ports, It can be connected to LCD which support DP signal input.

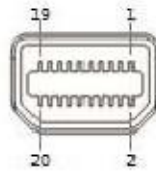


Figure 3-4

CN2 pin out definition

Pin	Signal	Pin	Signal
1	GND	11	DPB_TX1N
2	DPB_HPD_SINK	12	DPB_TX3N
3	DPB_TX0P	13	GND
4	DPB_CONFIG4	14	GND
5	DPB_TX0N	15	DPB_TX2P
6	DPB_CONFIG6	16	DPB_AUXP
7	GND	17	DPB_TX2N
8	GND	18	DPB_AUXN
9	DPB_TX1P	19	GND
10	DPB_TX3P	20	DPB_PWR

Table 3-4 MiniDP definition

CN3 pin out definition

Pin	Signal	Pin	Signal
1	GND	11	DPA_TX1N
2	DPA_HPD_SINK	12	DPA_TX3N
3	DPA_TX0P	13	GND
4	DPA_CONFIG4	14	GND
5	DPA_TX0N	15	DPA_TX2P
6	DPA_CONFIG6	16	DPA_AUXP
7	GND	17	DPA_TX2N
8	GND	18	DPA_AUXN
9	DPA_TX1P	19	GND
10	DPA_TX3P	20	DPA_PWR

Table 3-5 MiniDP definition

4.3.4 XMC and PMC Connectors

XMC connector pin out definition (PCIe bus)

PIN	A	B	C	D	E	F
1	PETp0	PETn0	VCC3V3	PETp1	PETn1	VPWR_XMC
2	GND	GND	NC	GND	GND	RST#
3	PETp2	PETn2	VCC3V3	PETp3	PETn3	VPWR_XMC
4	GND	GND	NC	GND	GND	NC
5	PETp4	PETn4	VCC3V3	PETp5	PETn5	VPWR_XMC
6	GND	GND	NC	GND	GND	+12V
7	PETp6	PETn6	VCC3V3	PETp7	PETn7	VPWR_XMC
8	GND	GND	NC	GND	GND	-12V
9	NC	NC	NC	NC	NC	VPWR_XMC
10	GND	GND	NC	GND	GND	NC
11	PERp0	PERn0	NC	PERp1	PERn1	VPWR_XMC
12	GND	GND	NC	GND	GND	GND
13	PERp2	PERn2	NC	PERp3	PERn3	VPWR_XMC
14	GND	GND	NC	GND	GND	NC
15	PERp4	PERn4	NC	PERp5	PERn5	VPWR_XMC
16	GND	GND	NC	GND	GND	NC
17	PERp6	PERn6	NC	PERp7	PERn7	NC
18	GND	GND	NC	GND	GND	NC
19	REFCLKp	REFCLKn	NC	NC	NC	VGA_SEL

Table 3–8

PMC connector signal pin out definition (TMDS)

PIN	Signal	PIN	Signal	PIN	Signal	PIN	Signal
1		17		33	GND	49	
2		18		34	VGA_BLUE	50	
3		19	TX3P_DPD2P	35	VGA_HYSNC	51	TX0P_DPC2P
4		20	TXCDP_DPD3P	36	VGADDC_DATA	52	TXCCP_DPC3P
5		21	TX3M_DPD2N	37		53	TX0M_DPC2N
6		22	TXCDM_DPD3N	38	GND	54	TXCCM_DPC3N
7		23		39	VGA_RED	55	
8		24		40	VGA_VSYNC	56	
9	DPD_SDA	25	TX4P_DPD1P	41	DPC_SDA	57	TX1P_DPC1P
10	DPD_SCL	26	TX5P_DPD0P	42		58	TX2P_DPC0P
11		27	TX4M_DPD1N	43	DPC_SCL	59	TX1M_DPC1N
12		28	TX5M_DPD0N	44	VGADDC_CLK	60	TX2M_DPC0N
13		29		45		61	GND
14		30		46		62	
15		31		47		63	VGA_GREEN
16		32		48		64	

Table 3—9